

2SK2220, 2SK2221

Silicon N Channel MOS FET

REJ03G1004-0200

(Previous: ADE-208-1352)

Rev.2.00 Sep 07, 2005

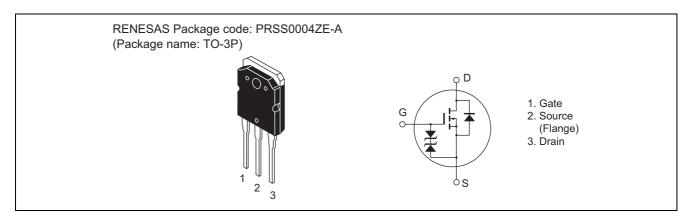
Application

Low frequency power amplifier Complementary pair with 2SJ351, 2SJ352

Features

- High power gain
- Excellent frequency response
- High speed switching
- Wide area of safe operation
- Enhancement-mode
- Good complementary characteristics
- Equipped with gate protection diodes

Outline



Absolute Maximum Ratings

 $(Ta = 25^{\circ}C)$

Item		Symbol	Ratings	Unit V
Drain to source voltage	source voltage 2SK2220		180	
	2SK2221		200	
Gate to source voltage		V _{GSS}	±20	V
Drain current		I_D	8	A
Body to drain diode reverse drain current		I _{DR}	8	Α
Channel dissipation		Pch*1	100	W
Channel temperature		Tch	150	°C
Storage temperature		Tstg	-55 to +150	°C

Note: 1. Value at Tc = 25°C

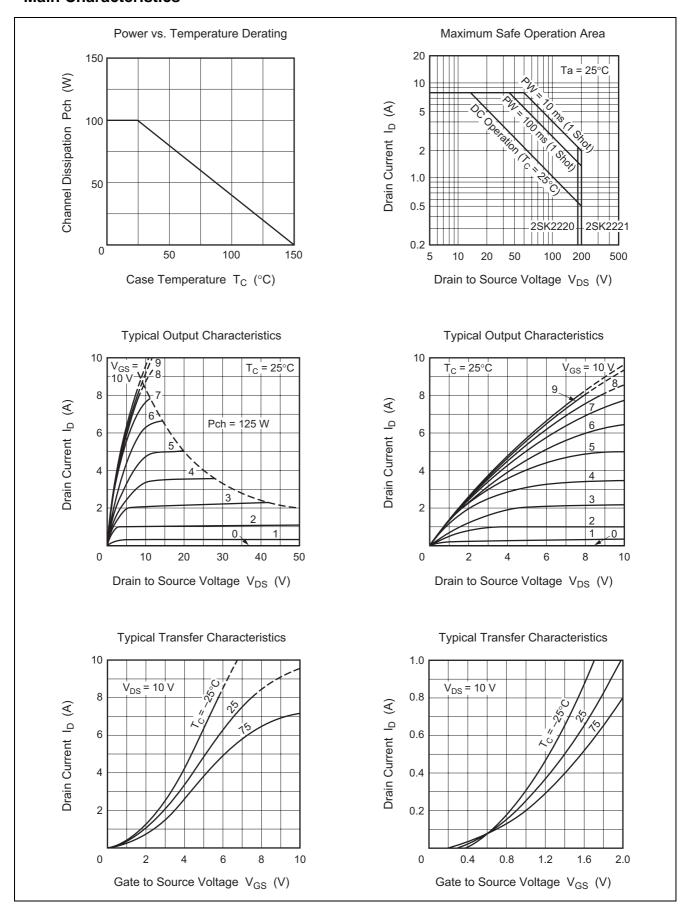
Electrical Characteristics

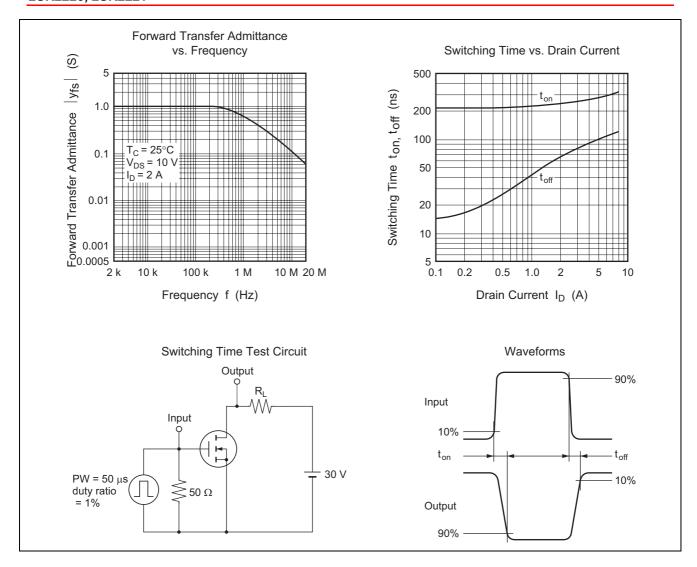
 $(Ta = 25^{\circ}C)$

Item		Symbol	Min	Тур	Max	Unit	Test conditions
Drain to source	2SK2220	$V_{(BR)DSX}$	180	_	_	V	$I_D = 10 \text{ mA}, V_{GS} = -10 \text{ V}$
breakdown voltage	2SK2221		200	_	_		
Gate to source breakdov	vn voltage	$V_{(BR)GSS}$	±20	_	_	V	$I_G = \pm 100 \ \mu A, \ V_{DS} = 0$
Gate to source cutoff vo	tage	$V_{GS(off)}$	0.15	_	1.45	V	$I_D = 100 \text{ mA}, V_{DS} = 10 \text{ V}$
Drain to source saturation	n voltage	V _{DS(sat)}	_	_	12	V	$I_D = 8 \text{ A}, V_{GD} = 0 \text{ V}^{*2}$
Forward transfer admittance		y _{fs}	0.7	1.0	1.4	S	$I_D = 3 \text{ A}, V_{DS} = 10 \text{ V}^{*2}$
Input capacitance		Ciss	_	600	_	pF	$V_{GS} = -5 \text{ V}, V_{DS} = 10 \text{ V},$
Output capacitance		Coss	_	800	_	pF	f = 1 MHz
Reverse transfer capacitance		Crss	_	8	_	pF	
Turn-on time		t _{on}		250	_	ns	$V_{DD} = 30 \text{ V}, I_{D} = 4 \text{ A}$
Turn-off time		t _{off}	_	90	_	ns	

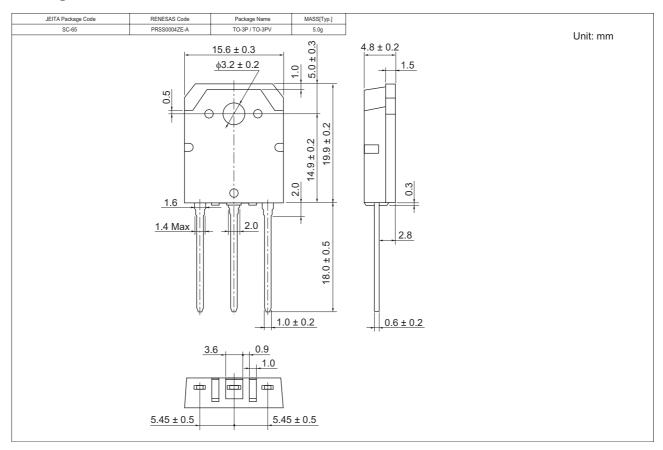
Note: 2. Pulse Test

Main Characteristics





Package Dimensions



Ordering Information

Part Name	Quantity	Shipping Container
2SK2220-E	360 pcs	Box (Tube)
2SK2221-E	360 pcs	Box (Tube)

Note: For some grades, production may be terminated. Please contact the Renesas sales office to check the state of production before ordering the product.

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